

# elementsix

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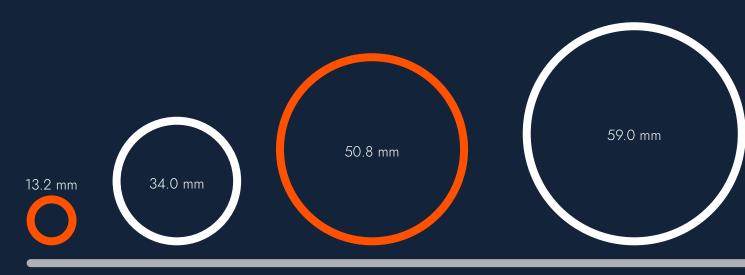
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Precision machining with polycrystalline diamond (PCD)
Giving toolmakers a competitive edge

## Competitive advantage through innovation

### 50 years of PCD expertise

Element Six (E6) polycrystalline diamond (PCD) solutions are the result of over half a century of relentless innovation. While quality and consistency are always at the core of what we do, our products have evolved over time to meet your changing needs.



1970's 1980's

### Our tailored product ranges

E6's PCD materials are produced and qualified to the highest standards. Our range of products is differentiated based on dimensions, tolerances and surface finish. This provides our customers with a wider and improved choice of products to suit the broad range of applications and industries our PCD materials are used in today.



E6 PCD disc

### 76.0 mm

### **E6 Superior**

range is built on E6's capability to control PCD layer and overall height into very tight dimensional tolerances while, at the same time, delivering a flawless polish quality. The combination of these advantages is achieved on the largest disc available in the market.

E6's Superior PCD materials are used for highend applications such as hole-making tools for the automotive industry or milling tools for producing smartphones, where high-quality surface finish is critical.

### **E6** Advanced

is E6's market-leading range of PCD products. E6 Advanced provides customers with two different disc diameters. The larger disc is ideal for large batch production, where the bigger certified area offers a significant advantage in cutting efficiency. The smaller disc is more suitable where the customer only needs to cut small volumes, to meet specific order batch sizes.

These materials are also used in high-precision applications and is more suitable for milling and turning tools.

### **E6 Assured**

is an ideal range for applications where dimensional tolerances may not be so critical. E6 Assured offers customers a competitively priced solution to enable higher volume applications.

These materials are also used in applications such as saw blades and routers in the woodworking industry.

### PCD grades and characteristics

Grade	Applications	Characteristics	Microstructure
CMX850	cutting of aluminium alloys where extreme chip resistance	Sub-micron grain size. Thanks to its extreme edge sharpness/retention, CMX850's ultra-fine grain structure is suitable for applications where mirror finishes are required	
CTX002	thread cutting tools, can	2 μm average grain size with increased cobalt for ease of processing. CTX002 is ideal for complex tools where intensive processing is required	
CTB004	alloys where high surface	4 µm average grain size. CTB004's 4-micron fine grain structure offers the optimum balance between tool performance and resistance to abrasions and chips	
CTB010	and finishing performed with a single tool. Highly	10 µm average grain size. CTB010 is E6's workhorse PCD grade, ideal for applications where a good balance of toughness and wear resistance is required	
CTH025	high silicon aluminium alloys,	Average grain size of 25 µm. CTH025 offers optimum wear resistance for abrasive machining conditions	
CTM302	MMC, high silicon aluminium	A multi-modal PCD with grain size ranging from 2 µm. to 30 µm, giving CTM302 excellent wear resistance, edge strength and quality, as well as outstanding abrasion resistance and good thermal stability	

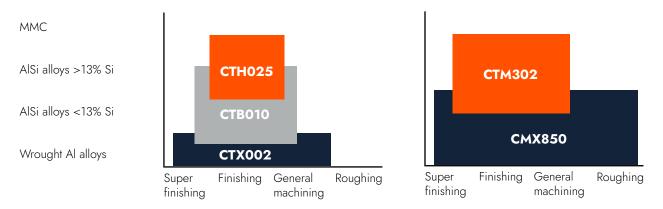
### Choosing the right PCD grades

### PCD grades for general machining

Improvements in synthesis techniques coupled with new product development capabilities have resulted in two PCD grades, CMX850 and CTM302, that possess the properties to meet all known tool performance challenges in the industry. CTM302 provides the ultimate abrasion resistance while CMX850 provides the optimum balance of processability and performance.

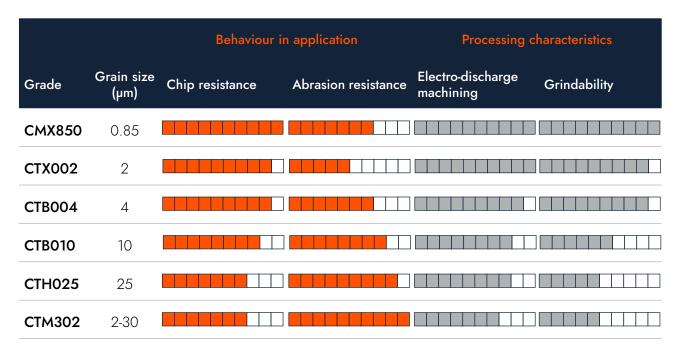
### Four key factors to consider when selecting your E6 PCD grades 1. Chip resistance 2. Abrasion resistance 3. Electro-discharge characteristics 4. Grindability characteristics Processing characteristics

### Workpiece abrasivity

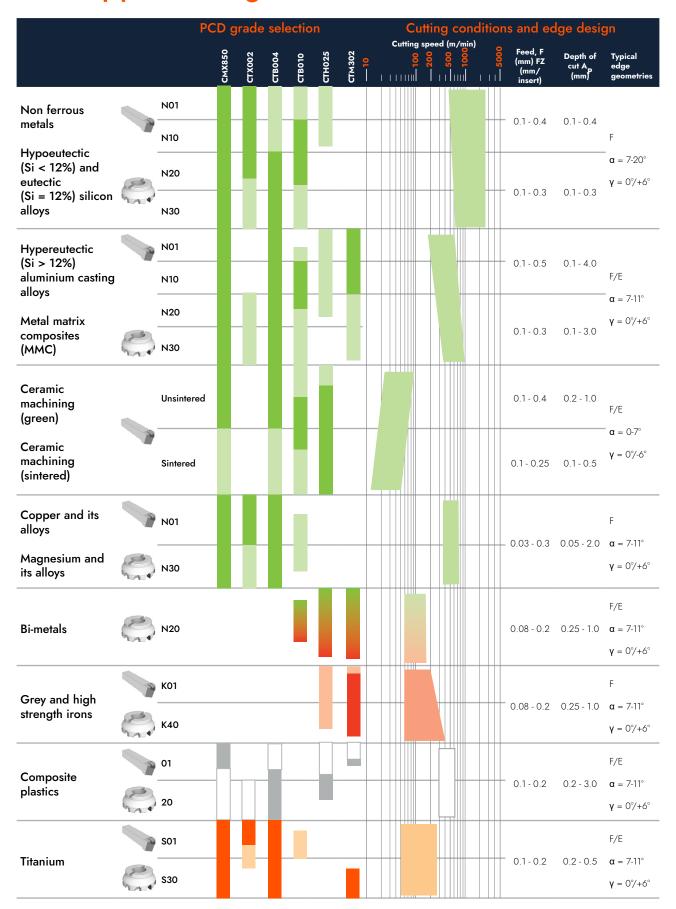


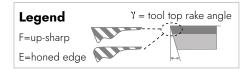
### Materials and machining

E6's PCD grades provide the ideal balance between behaviour in application and processing characteristics to meet the requirements of your cutting and grinding operations.



### PCD application guide



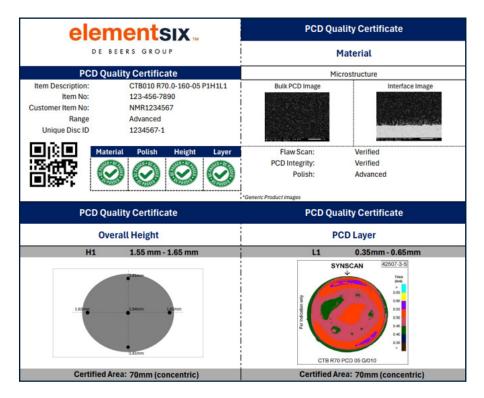


Work material characteristics and, to a lesser extent, cutting parameters, determine the demands placed on the cutting tool and, hence, the optimum balance of tool material properties. Knowledge of the application, including workpiece composition, facilitates selection of the optimum grade and correct tool geometry. Often, work material composition and machining parameters (vc, f, ap) are closely correlated. It is possible, therefore, only to provide a typical range of values for each parameter.



### PCD product range

Grade	Standard PCD layer (mm)	Overall height (mm)							
	iayer (mm)	0.8	1.0	1.2	1.4	1.6	2.0	3.18	8.0
	0.3	<b>/</b>	<b>/</b>	<b>/</b>		<b>/</b>			
CMX850	0.5		<b>/</b>			<b>/</b>	<b>/</b>		
	1.0							<b>/</b>	
CTX002	0.5		<b>/</b>			<b>/</b>		<b>/</b>	
CTB004	0.5					<b>/</b>			
	0.3	<b>/</b>	<b>/</b>	<b>/</b>	<b>/</b>	<b>/</b>			
	0.5		<b>/</b>	<b>/</b>		<b>/</b>	<b>/</b>	<b>/</b>	
CTB010	0.7					<b>/</b>		<b>/</b>	<b>/</b>
	1.0							<b>/</b>	
CTH025	0.5					<b>/</b>	<b>/</b>	<b>/</b>	
	0.5					<b>/</b>	<b>/</b>		
CTM302	0.7							<b>/</b>	
	1.5							<b>/</b>	<b>/</b>



### Quality certificate

E6 supplies a detailed quality certificate alongside each PCD product. The certificate provides:

- Traceability quality steps and records
- Material quality validation
- Unique disc ID
- Microstructure
- Ultrasonic fault analysis
- Attribute validation
- Polish quality
- Layer height
- Overall height

Example of E6 quality certificate

### Aero-Dianamics™ PCD round tool blanks

### **Grades and characteristics**

Grade	Applications	Grain sizes	Characteristics
A2DS chevron	Drilling	Coarse	<ul> <li>Tool life extended by 10 times compared to tungsten carbide drills</li> <li>Half round disc formats available</li> <li>Electrical discharge machining (EDM) segments available and cut to order</li> </ul>
A3DP planar	Drilling	Fine	<ul> <li>Virtually infinite flexibility in drill point geometry</li> <li>Tool life extended by 10 times compared to tungsten carbide drills</li> <li>Large rake angles available for lower tool forces</li> </ul>





### Sustainability at E6

Through the De Beers Group, E6 is a member of the UN Global Compact (UNGC). The UNGC drives business awareness and action towards the UN Sustainable Development Goals (SDGs), focussing on 10 principles around human rights, labour, environment and anti-corruption. E6 works within the De Beers Group Building Forever commitment and Science Based Target Initiative (STBi), which is also based on the UNGC principles.

We incorporate and take responsibility for these principles through the E6 Code of Conduct, Our Values, Responsibilities and Policies.

Our sites in Ireland and Germany are ISO 50001 certified.

At E6, we have active communities working towards sustainability from a variety of angles, such as environmental impact, inclusion, diversity and community outreach, both internally and externally.

### Our sustainability principles



### (()) ENERGY & EMISSIONS

We strive for maximum energy efficiency.

We are committed to renewable energies and use them as much as possible.

Energy efficiency must be an essential factor in the development of processes and products as well as in the purchase of machines and changes to the infrastructure.

We strive to improve our carbon footprint and continuously avoid wasting energy.



### **USE OF RESOURCES**

We are committed to recyclable resources and use them as much as possible.

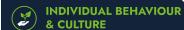
Our goal is sustainable water management.

We will avoid waste as much as possible.

Avoiding waste must be a key factor in the development of processes and products, as well as in the purchase of machines and changes to the infrastructure.

We conscientiously dispose of unavoidable hazardous waste

> **REDUCE REUSE RECYCLE**



We educate our employees, customers and suppliers about important issues regarding sustainability and motivate them to act themselves

We strive to improve sustainability across the whole supply chain, by working together with external parties to shape the future.

We are leading the way in terms of climate protection, environmental protection and sustainability.

**RENEWABLE ENERGIES ENERGY EFFICIENCY** ISO 50001 **ENLIGHTENMENT COLLABORATION TRANSPARENCY** 

Datasheets

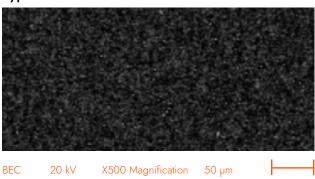
### Grade: CMX850

### Key material characteristics

- 0.85 µm diamond grain size
- ≥15 % cobalt ratio (wt %)
- High chip resistance

Ideal for milling and rough cutting of aluminium alloys where extreme chip resistance is required, can also be used for machining titanium and composites. Sub-micron grain size. CMX850's ultrafine grain structure is suitable for applications where mirror finishes are required due to its extreme edge sharpness/retention.

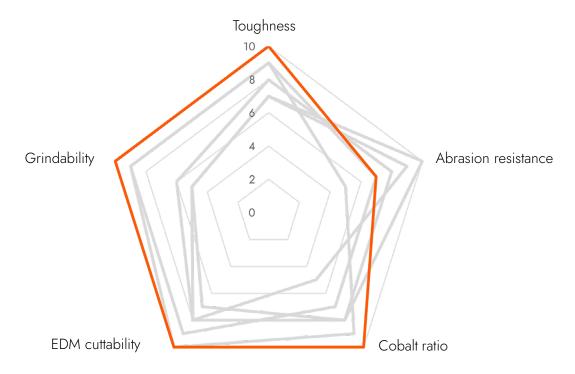
### Typical microstructure



	Behaviour ii	Behaviour in application Processing characteristics		
<b>Grade</b> Grain size	Chip resistance	Abrasion resistance	Electro-discharge machinability	Grindability
<b>CMX850</b> 0.85 μm				
<b>CTX002</b> 2 μm				
<b>CTB004</b> 4 μm				
<b>CTB010</b> 10 μm				
<b>CTH025</b> 25 μm				
<b>CTM302</b> 2 - 30 μm				

		S	ize and forr	nat availab	le			
Maximum disc diamet	<b>er:</b> 76 mm	76 mm Maximum PCD certified area: 70 mm						
				Overal	l height			
PCD layer thickness	0.8	1.0	1.2	1.4	1.6	2.0	3.18	8.0
0.3	<b>/</b>	<b>/</b>	<b>/</b>		<b>/</b>			
0.5		<b>/</b>			<b>/</b>	<b>/</b>		
1.0							<b>/</b>	

### Material characteristics



Grade: CMX850

Physical and metallurgical properties							
Property	Measurement	Applicable standard					
Mean coefficient of thermal expansion (10 <sup>-6</sup> /°C) for temperature range 150 °C to 500 °C	4.2	ASTM E228-06					
Transverse rupture strenght characteristic strengh (MPa)	2387	_ ASTM C1239					
Weibull modulus	6						
Fracture toughness mean (MPa.m½)	11.3 - 15.5	Shetty et al. (1995)					
Elastic modulus (GPa)	827	ASTM E494					
Poisson's ratio	0.08	ASIM E494					
Density (g/cm³)	4.37	Archimedes principle					
Thermal conductivity (W/m/K) at 500 °C	253.5	Calculated from thermal diffusivity, specific heat capacity and density					
Knoop hardness (Indentation)(GPa)	50	ASTM C1326-03					

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	Superior	Advanced	Assured
Polish quality	P+	P1	P2
Overall height tolerance + - mm	<b>H+</b>	<b>H1</b>	<b>H2</b>
	0.025	0.05	0.1
PCD layer tolerance + - mm	<b>L+</b>	<b>L1</b>	<b>L2</b>
	0.1	0.15	0.2

Range	PCD layer (mm)	Certified area (mm)	Overall height (mm)	Nomenclature	Item number
Advanced	0.3	70	1.6	CMX850 R70-160-03 P1H1L1	245-200-0322-01
Advanced	0.3	70	1.2	CMX850 R70-120-03 P1H1L1	245-200-0339-01
Advanced	0.3	70	1.0	CMX850 R70-100-03 P1H1L1	245-200-0351-01
Advanced	0.3	70	0.8	CMX850 R70-080-03 P1H1L1	245-200-0342-01
Superior	0.5	70	1.6	CMX850 R70-160-05 P+H+L+	245-200-0317-01
Advanced	0.5	70	1.6	CMX850 R70-160-05 P1H1L1	245-200-0309-01
Advanced	0.5	70	2.0	CMX850 R70-200-05 P1H1L1	245-200-0329-01
Superior	0.5	70	1.6	CMX850 R70-160-05 P+H1L+	245-200-0314-01
Advanced	0.5	70	1.2	CMX850 R70-120-05 P1H1L1	245-200-0337-01
Superior	0.5	70	1.0	CMX850 R70-100-05 P+H1L+	245-200-0327-01
Advanced	0.5	70	1.0	CMX850 R70-100-05 P1H1L1	245-200-0325-01
Assured	0.5	68	1.6	CMX850 R68-160-05 P2H1L1	245-200-0313-01
Advanced	1.0	70	3.2	CMX850 R70-318-10 P1H1L1	245-200-0333-01
Advanced	1.0	70	3.2	CMX850 R70-318-10 U1H1L1	245-200-0355-01
Assured	0.5	68	1.6	CMX850 R68-160-05 P2H1L1	245-200-0313-01
Advanced	0.5	60	1.6	CMX850 R60-160-05 P1H1L1	245-200-0311-01





Datasheets

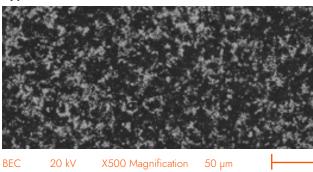
### Grade: CTX002

### Key material characteristics

- 2 µm diamond grain size
- 13 % cobalt ratio (wt %)
- High chip resistance

ldeal for profile routers and thread cutting tools, can also be used in wear part applications. 2  $\mu m$  average grain size with increased cobalt for ease of processing. CTX002 is ideal for complex tools where intensive processing is required.

### Typical microstructure



	Behaviour i	n application	Processing ch	aracteristics
<b>Grade</b> Grain size	Chip resistance	Abrasion resistance	Electro-discharge machinability	Grindability
<b>CMX850</b> 0.85 μm				
<b>CTX002</b> 2 μm				
<b>CTB004</b> 4 μm				
<b>CTB010</b> 10 μm				
<b>CTH025</b> 25 μm				
<b>CTM302</b> 2 - 30 μm				

Size and format available								
Maximum disc diamete			Maximum	PCD certifi	ed area: 7	0 mm		
				Overal	l height			
PCD layer thickness	8.0	1.0	1.2	1.4	1.6	2.0	3.18	8.0
0.5		<b>/</b>			<b>✓</b>		<b>✓</b>	

### Material characteristics



Grade: CTX002

Physical and metallurgical properties							
Property	Measurement	Applicable standard					
Transverse rupture strenght characteristic strengh (MPa)	2175	_ ASTM C1239					
Weibull modulus	7.1						
Fracture toughness mean (MPa.m <sup>1/2</sup> )	9.12	Shetty et al. (1995)					
Elastic modulus (GPa)	950	— ACTNA F 40.4					
Poisson's ratio	0.1	ASTM E494					
Density (g/cm³)	4.36	Archimedes principle					
Thermal conductivity (W/m/K) at 500 °C	304.3	Calculated from thermal diffusivity, specific heat capacity and density					
Knoop hardness (Indentation)(GPa)	45	ASTM C1326-03					

Grade: CTX002

	Superior	Advanced	Assured
Polish quality	P+	P1	P2
Overall height tolerance + - mm	<b>H+</b> 0.025	<b>H1</b> 0.05	<b>H2</b> 0.1
PCD layer tolerance + - mm	<b>L+</b> 0.1	<b>L1</b> 0.15	<b>L2</b> 0.2

Range	PCD layer (mm)	Certified area (mm)	Overall height (mm)	Nomenclature	Item number
Advanced	0.5	70	1.6	CTX002 R70-160-05 P1H1L+	176-200-0043-01
Advanced	0.5	70	0.8	CTX002 R70-080-05 P1H1L+	176-200-0052-01
Advanced	0.5	70	1.0	CTX002 R70-100-05 P1H1L+	176-200-0049-01
Advanced	0.5	70	1.2	CTX002 R70-120-05 P1H1L+	176-200-0048-01
Advanced	0.5	70	1.6	CTX002 R70-140-05 P1H1L+	176-200-0054-01
Advanced	0.5	70	2.0	CTX002 R70-200-05 P1H1L+	176-200-0046-01
Advanced	0.5	70	3.18	CTX002 R70-318-05 P1H1L+	176-200-0047-01
Assured	0.5	68	1.6	CTX002 R68-160-05 P2H2L1	176-200-0042-01
Assured	0.5	68	2.0	CTX002 R68-200-05 P2H2L1	176-200-0045-01
Assured	0.5	68	3.18	CTX002 R68-318-05 U1H2L1	176-200-0056-01
Assured	0.5	68	1.6	CTX002 R68-160-05 U1H2L1	176-200-0058-01
Advanced	0.5	60	1.6	CTX002 R60-160-05 P1H1L1	176-200-0044-01





### Datasheets

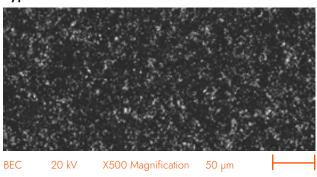
### Grade: CTB004

### Key material characteristics

- 4 µm diamond grain size
- 10 % cobalt ratio (wt %)
- High wear resistance

Ideal for cutting aluminium alloys where high surface finish is required, alongside higher wear resistance. 4 µm average grain size. CTB004's finer grain structure offers optimum balance between tool performance and resistance to abrasion and chipping.

### Typical microstructure



	Behaviour i	n application	Processing characteristics		
<b>Grade</b> Grain size	Chip resistance	Abrasion resistance	Electro-discharge machinability	Grindability	
<b>CMX850</b> 0.85 μm					
<b>CTX002</b> 2 μm					
<b>CTB004</b> 4 μm					
<b>CTB010</b> 10 μm					
<b>CTH025</b> 25 μm					
<b>CTM302</b> 2 - 30 μm					

Size and format available								
Maximum disc diamete			Maximum	PCD certif	ied area: 7	0 mm		
				Overall height				
PCD layer thickness	8.0	1.0	1.2	1.4	1.6	2.0	3.18	8.0
0.5					<b>/</b>			

### Material characteristics



Grade: CTB004

Physical and metallurgical properties						
Property	Measurement	Applicable standard				
Transverse rupture strenght characteristic strengh (MPa)	1921	_ ASTM C1239				
Weibull modulus	6.35					
Fracture toughness mean (MPa.m <sup>1/2</sup> )	9.15	Shetty et al. (1995)				
Elastic modulus (GPa)	950	— A CTNA F 4O 4				
Poisson's ratio	0.1	ASTM E494				
Density (g/cm³)	4.19	Archimedes principle				
Thermal conductivity (W/m/K) at 500 °C	248.1	Calculated from thermal diffusivity, specific heat capacity and density				
Knoop hardness (Indentation)(GPa)	47	ASTM C1326-03				

	Superior	Advanced	Assured
Polish quality	P+	P1	P2
Overall height tolerance + - mm	<b>H+</b> 0.025	<b>H1</b> 0.05	<b>H2</b> 0.1
PCD layer tolerance + - mm	<b>L+</b> 0.1	<b>L1</b> 0.15	<b>L2</b> 0.2

Range	PCD layer (mm)	Certified area (mm)	Overall height (mm)	Nomenclature	Item number
Superior	0.5	70	1.6	CTB004 R70-160-05 P1H+L+	184-200-0051-01
Advanced	0.5	70	1.4	CTB004 R70-140-05 P1H+L1	184-200-0058-01
Superior	0.5	70	1.5	CTB004 R70-150-05 P1H+L+	184-200-0057-01
Advanced	0.5	70	0.6	CTB004 R70-160-05 P1H1L1	184-200-0049-01
Advanced	0.5	70	2.0	CTB004 R70-200-05 P1H1L1	184-200-0055-01
Advanced	0.5	68	1.6	CTB004 R68-160-05 P1H1L1	184-200-0054-01
Assured	0.5	68	1.6	CTB004 R68-160-05 P2H2L2	184-200-0053-01
Assured	0.5	68	2.0	CTB004 R68-200-05 P2H2L1	184-200-0056-01
Assured	0.5	68	1.6	CTB004 R68-160-05 P2H2L1	184-200-0050-01
Advanced	0.5	60	1.6	CTB004 R60-160-05 P1H1L1	184-200-0052-01





Datasheets

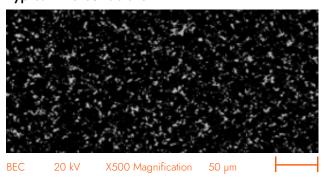
### Grade: CTB010

### Key material characteristics

- 10 µm diamond grain size
- 10 13 % cobalt ratio (wt %)
- Balanced performance

The ideal grade for roughing and finishing performed with a single tool. Highly recommended for low to medium content aluminium alloys. 10  $\mu$ m grain size. CTB010 is E6's workhorse PCD grade, ideal for applications where a good balance of toughness and wear resistance is required.

### Typical microstructure



	Behaviour i	n application	Processing characteristics		
<b>Grade</b> Grain size	Chip resistance	Abrasion resistance	Electro-discharge machinability	Grindability	
<b>CMX850</b> 0.85 μm					
<b>CTX002</b> 2 μm					
<b>CTB004</b> 4 μm					
<b>CTB010</b> 10 μm					
<b>CTH025</b> 25 μm					
<b>CTM302</b> 2 - 30 μm					

Size and format available								
Maximum disc diamet	<b>er:</b> 76 mm			Maximum	PCD certif	ied area: 7	O mm	
				Overal	l height			
PCD layer thickness	0.8	1.0	1.2	1.4	1.6	2.0	3.18	8.0
0.3	<b>/</b>	<b>✓</b>	<b>/</b>	<b>✓</b>	<b>✓</b>			
0.5		<b>✓</b>	<b>✓</b>		<b>/</b>	<b>/</b>	<b>✓</b>	
0.7					<b>/</b>		<b>✓</b>	<b>/</b>
1.0							<b>✓</b>	

### Material characteristics



Grade: CTB010

Physical and metallurgical properties						
Measurement	Applicable standard					
4.0	ASTM E228-06					
1890	_ ASTM C1239					
8.2						
8.19 - 9.73	Shetty et al. (1995)					
1000	— ACTA4 F 40.4					
0.1	ASTM E494					
4.09	Archimedes principle					
365.6	Calculated from thermal diffusivity, specific heat capacity and density					
50	ASTM C1326-03					
	Measurement         4.0         1890         8.2         8.19 - 9.73         1000         0.1         4.09         365.6					

	Superior	Advanced	Assured
Polish quality	P+	P1	P2
Overall height tolerance + - mm	<b>H+</b> 0.025	<b>H1</b> 0.05	<b>H2</b> 0.1
PCD layer tolerance + - mm	<b>L+</b> 0.1	<b>L1</b> 0.15	<b>L2</b> 0.2

### Grade: CTB010

Range	PCD layer (mm)	Certified area (mm)	Overall height (mm)	Nomenclature	Item number
Advanced	0.3	70	1.6	CTB010 R70-150-03 P1H1L1	180-200-2912-01
Advanced	0.3	70	1.6	CTB010 R70-160-03 P+H1L1	180-200-2887-01
Advanced	0.3	70	1.6	CTB010 R70-160-03 P1H1L1	180-200-2886-01
Assured	0.3	70	1.2	CTB010 R70-120-03 P1H1L1	180-200-2922-01
Advanced	0.3	70	1.0	CTB010 R70-100-03 P1H1L1	180-200-2930-01
Advanced	0.3	70	0.8	CTB010 R70-080-03 P1H1L1	180-200-2928-01
Advanced	0.3	60	1.6	CTB010 R60-160-03 P1H1L1	180-200-2888-01
Advanced	0.3	60	1.0	CTB010 R60-100-03 P1H1L1	180-200-2932-01
Advanced	0.5	70	1.6	CTB010 R70-160-05 P1H1L+	180-200-2875-01
Superior	0.5	70	1.6	CTB010 R70-160-05 P+H1L+	180-200-2881-01
Superior	0.5	70	1.6	CTB010 R70-160-05 P+H1L+	180-200-2881-01
Assured	0.5	70	2.0	CTB010 R70-200-05 P1H1L+	180-200-2889-01
Advanced	0.5	70	1.0	CTB010 R70-100-05 P1H1L+	180-200-2908-01
Advanced	0.5	70	1.4	CTB010 R70-140-05 P1H1L+	180-200-2923-01
Assured	0.5	70	1.2	CTB010 R70-120-05 P1H1L+	180-200-2920-01
Advanced	0.5	70	1.1	CTB010 R70-110-05 P1H1L+	180-200-2918-01
Advanced	0.5	70	3.18	CTB010 R70-318-05 P1H1L+	180-200-2896-01
Advanced	0.5	60	1.6	CTB010 R60-160-05 P1H1L1	180-200-2880-01
Assured	0.5	60	2.0	CTB010 R60-200-05 P1H1L1	180-200-2894-01
Assured	0.5	68	1.6	CTB010 R68-160-05 P2H2L1	180-200-2876-01
Assured	0.5	68	2.0	CTB010 R68-200-05 P2H2L1	180-200-2890-01
Assured	0.5	68	3.18	CTB010 R68-318-05 P2H2L1	180-200-2895-01
Assured	0.5	68	2.0	CTB010 R68-200-05 P2H2L1	180-200-2890-01
Assured	0.5	68	1.6	CTB010 R68-160-05 U1H2L1	180-200-2940-01
Assured	0.5	68	2.0	CTB010 R68-200-05 U1H2L1	180-200-2938-01
Advanced	0.7	70	8.0	CTB010 R70-800-07 P1H1L1	180-200-2904-01
Advanced	0.7	70	3.18	CTB010 R70-318-07 P1H1L1	180-200-2902-01
Advanced	1.0	70	3.18	CTB010 R70-318-10 P1H1L1	180-200-2900-01

Datasheets

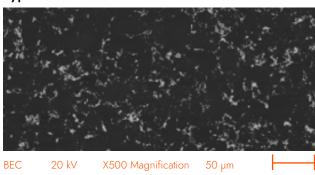
### Grade: CTH025

### Key material characteristics

- 25 µm diamond grain size
- 8 % cobalt ratio (wt %)
- High wear resistance

Suitable for machining of high silicon aluminium alloys, metal matrix composites (MMC), tungsten carbide and ceramics. Average grain size of 25  $\mu m.$  CTH025 offers optimum wear resistance for abrasive machining conditions.

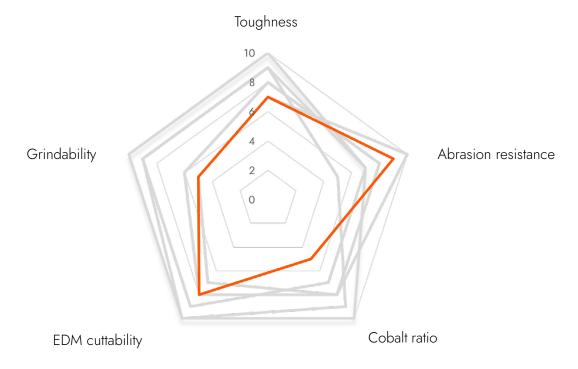
### Typical microstructure



	Behaviour i	in application	Processing characteristics		
<b>Grade</b> Grain size	Chip resistance	Abrasion resistance	Electro-discharge machinability	Grindability	
<b>CMX850</b> 0.85 μm					
<b>CTX002</b> 2 μm					
<b>CTB004</b> 4 μm					
<b>CTB010</b> 10 μm					
<b>CTH025</b> 25 μm					
<b>CTM302</b> 2 - 30 μm					

		S	ize and for	mat availab	le			
Maximum disc diameter: 76 mm Maximum PCD certified area: 70 mm					O mm			
				Overal	l height			
PCD layer thickness	0.8	1.0	1.2	1.4	1.6	2.0	3.18	8.0
0.5					<b>/</b>	<b>/</b>	<b>/</b>	

### Material characteristics



Grade: CTH025

Physical and metallurgical properties							
Property	Measurement	Applicable standard					
Transverse rupture strenght characteristic strengh (MPa)	1154	_ ASTM C1239					
Weibull modulus	8.34						
Fracture toughness mean (MPa.m <sup>1/2</sup> )	9.3	Shetty et al. (1995)					
Elastic modulus (GPa)	1100	— ACTAA F 40.4					
Poisson's ratio	0.1	ASTM E494					
Density (g/cm³)	3.79	Archimedes principle					
Thermal conductivity (W/m/K) at 500 °C	336.16	Calculated from thermal diffusivity, specific heat capacity and density					
Knoop hardness (Indentation)(GPa)	62	ASTM C1326-03					

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	Superior	Advanced	Assured
Polish quality	P+	P1	P2
Overall height tolerance + - mm	<b>H+</b> 0.025	<b>H1</b> 0.05	<b>H2</b> 0.1
PCD layer tolerance + - mm	<b>L+</b> 0.1	<b>L1</b> 0.15	<b>L2</b> 0.2

Range	PCD layer (mm)	Certified area (mm)	Overall height (mm)	Nomenclature	Item number
Superior	0.5	70	1.6	CTH025 R70-160-05 P1H+L+	195-200-0977-01
Advanced	0.5	70	1.6	CTH025 R70-160-05 P1H1L+	195-200-0975-01
Advanced	0.5	70	1.0	CTH025 R70-100-05 P1H1L+	195-200-0986-01
Advanced	0.5	70	2.0	CTH025 R70-200-05 P1H1L+	195-200-0985-01
Advanced	0.5	70	3.18	CTH025 R70-318-05 P1H1L+	195-200-0982-01
Assured	0.5	70	1.6	CTH025 R68-160-05 P2H2L1	195-200-0976-01
Assured	0.5	70	1.6	CTH025 R68-160-05 U1H2L1	195-200-0991-01
Assured	0.5	70	2.0	CTH025 R68-200-05 U1H2L1	195-200-0987-01
Assured	0.5	70	2.0	CTH025 R68-200-05 P2H2L1	195-200-0984-01
Assured	0.5	70	3.18	CTH025 R68-318-05 P2H2L1	195-200-0981-01
Assured	0.5	70	3.18	CTH025 R68-318-05 U1H2L1	195-200-0990-01
Advanced	0.5	70	1.6	CTH025 R60-160-05 P1H1L1	195-200-0980-01





Datasheets

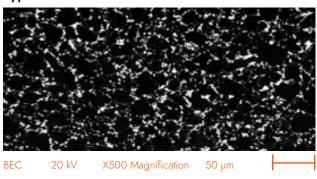
### Grade: CTM302

### Key material characteristics

- Bi-modal 30 & 2 µm diamond grain size
- 10 13 % cobalt ratio (wt %)
- Highest wear resistance

Application areas include MMC, high silicon aluminium alloys, high strength cast irons and bimetal applications. excellent abrasion resistance and good thermal stability. A multi-modal PCD with grain size ranging from 2  $\mu m$ . to 30  $\mu m$ , giving CTM302 excellent wear resistance, edge strength and quality, as well as outstanding abrasion resistance and good thermal stability.

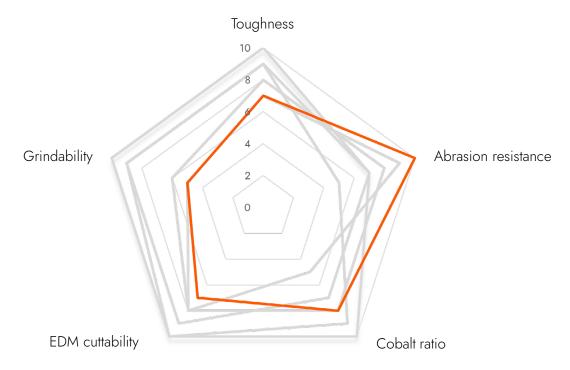
### Typical microstructure



	Behaviour i	in application	Processing characteristics		
<b>Grade</b> Grain size	Chip resistance	Abrasion resistance	Electro-discharge machinability	Grindability	
<b>CMX850</b> 0.85 μm					
<b>CTX002</b> 2 μm					
<b>CTB004</b> 4 μm					
<b>CTB010</b> 10 μm					
<b>CTH025</b> 25 μm					
<b>CTM302</b> 2 - 30 μm					

		Si	ize and for	mat availab	le			
Maximum disc diamet	<b>er:</b> 76 mm			Maximum	PCD certif	ied area: 7	0 mm	
				Overal	l height			
PCD layer thickness	8.0	1.0	1.2	1.4	1.6	2.0	3.18	8.0
0.5					<b>/</b>	<b>/</b>		
0.7							<b>~</b>	
1.5							<b>/</b>	<b>✓</b>

### Material characteristics



Grade: CTM302

Physical and metallurgical properties							
Property	Measurement	Applicable standard					
Mean coefficient of thermal expansion (10 $^{-6}$ /°C) for temperature range 150 °C to 500 °C	3.5	ASTM E228-06					
Transverse rupture strenght characteristic strengh (MPa)	1521	_ ASTM C1239					
Weibull modulus	6.4						
Fracture toughness mean (MPa.m½)	8.56 - 10.12	Shetty et al. (1995)					
Elastic modulus (GPa)	883	— A CTNA F 4 O 4					
Poisson's ratio	0.109	ASTM E494					
Density (g/cm³)	3.91	Archimedes principle					
Thermal conductivity (W/m/K) at 500 °C	402.5	Calculated from thermal diffusivity, specific heat capacity and density					
Knoop hardness (Indentation)(GPa)	50	ASTM C1326-03					

Grade: CTM302

	Superior	Advanced	Assured
Polish quality	P+	P1	P2
Overall height tolerance + - mm	<b>H+</b> 0.025	<b>H1</b> 0.05	<b>H2</b> 0.1
PCD layer tolerance + - mm	<b>L+</b> 0.1	<b>L1</b> 0.15	<b>L2</b> 0.2

Range	PCD layer (mm)	Certified area (mm)	Overall height (mm)	Nomenclature	Item number
Advanced	0.5	70	1.6	CTM302 R70-160-05 P1H1L1	215-200-0417-01
Advanced	0.5	70	1.6	CTM302 R70-160-05 P1H+L1	215-200-0418-01
Advanced	0.5	70	2.0	CTM302 R70-200-05 P1H1L1	215-200-0413-01
Advanced	0.7	70	1.6	CTM302 R70-160-07 P1H1L1	215-200-0428-01
Advanced	0.7	70	3.18	CTM302 R70-318-07 P1H1L1	215-200-0408-01
Advanced	0.5	70	3.18	CTM302 R70-318-07 U1H1L1	215-200-0433-01
Advanced	0.7	70	4.76	CTM302 R70-476-07 P1H1L1	215-200-0430-01
Advanced	0.7	70	8.0	CTM302 R70-800-07 P1H1L1	215-200-0421-01
Advanced	0.7	70	8.0	CTM302 R70-800-07 P1H1L1	215-200-0421-01
Advanced	1.5	70	8.0	CTM302 R70-800-15 P1H1L1	215-200-0411-01
Advanced	1.5	70	8.0	CTM302 R70-800-15 U1H1L1	215-200-0432-01
Assured	0.5	68	1.6	CTM302 R68-160-05 U1H2L1	215-200-0434-01
Assured	0.5	68	1.6	CTM302 R68-160-05 P2H2L1	215-200-0416-01
Assured	0.5	68	2.0	CTM302 R68-200-05 P2H2L1	215-200-0414-01
Assured	0.5	68	2.0	CTM302 R68-200-05 P2H2L1	215-200-0414-01
Assured	0.7	68	3.18	CTM302 R68-318-07 P2H2L1	215-200-0409-01







Element Six is a global leader in the development and production of synthetic diamond and tungsten carbide solutions. For over 70 years, our innovation expertise has enabled a wide range of industries, from aerospace and mining, to semiconductors and sensing. Part of the De Beers Group, our primary manufacturing sites are located in the US, UK, Ireland, Germany and South Africa.

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